



PCB Layout Diagram  
Top View

**NOTE:**

**1. MATERIAL:**

- a. HOUSING: THERMOPLASTIC GLASS FIBRE UL94V-0
- b. CONTACT: PHOSPHOR BRONZE  
(SURFACE PLATING: A\*U")

SEE ORDERING INFORMATION

**2. ELECTRIC:**

- a. CONTACT RESISTANCE: 30 MILLIOHMS MAX
- b. INSULATION RESISTANCE: 1000 MEGA OHMS MIN
- c. DIELECTRIC VOLTAGE: 500V AC ONE SEC LEVEL
- d. OPERATING TEMPERATURE: -25 ° C ~ +85 ° C

3	TERMINAL (-)	1	PHOSPHOR BRONZE, T=0.20MM	Gold Plating and Ni Under-Plating
2	TERMINAL (+)	1	PHOSPHOR BRONZE, T=0.20MM	Gold Plating and Ni Under-Plating
1	HOUSING	1	LCP	WHITE
V0	PART NAME	0' TY	MATERIAL	PLATING & COLOR

ECN NO.	REV.	DATE.	DESCRIPTION.	CHANGE.	CHECK.	APPRO.
	A		NEW			

<b>APPROVALS</b>		<b>DATE</b>	<b>TITILE:</b>			
<b>DRAWN</b>	ZHIWEI.CHEN	2015.07.07	深圳市联丰电子有限公司			
<b>CHECKED</b>			SHENZHEN LINFENG ELECTRONIC CO.,LTD			
<b>APPROVALS</b>			<b>PART NO.</b>	GP07-CR2032-06	<b>SCALE:</b>	1:1
<b>TOLERANCES ARE</b>	30~以上 ±0.30	ANGLE	UNIT:	mm	<b>PROJ:</b>	
	10~30 ±0.20		<b>DRAWING NO.</b>		<b>SHEET</b>	1 OF 1
	5~10 ±0.15	±2°				
	~ 5 ±0.10					